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[International Rectifier \(Infineon Technologies Americas Corp.\)](#)
[IRFIZ46NPBF](#)

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sales@integrated-circuit.com

International **IR** Rectifier

PD - 95595

IRFIZ46NPbF

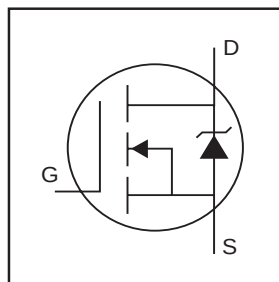
HEXFET® Power MOSFET

- Advanced Process Technology
- Isolated Package
- High Voltage Isolation = 2.5KVRMS ⑤
- Sink to Lead Creepage Dist. = 4.8mm
- Fully Avalanche Rated
- Lead-Free

Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve the lowest possible on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient device for use in a wide variety of applications.

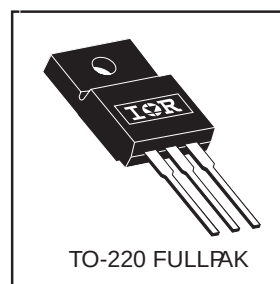
The TO-220 Fullpak eliminates the need for additional insulating hardware in commercial-industrial applications. The moulding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The Fullpak is mounted to a heatsink using a single clip or by a single screw fixing.



$$V_{DSS} = 55V$$

$$R_{DS(on)} = 0.020\Omega$$

$$I_D = 33A$$



TO-220 FULLPAK

Absolute Maximum Ratings

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	33	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	23	
I_{DM}	Pulsed Drain Current ①⑥	180	
$P_D @ T_C = 25^\circ C$	Power Dissipation	45	W
	Linear Derating Factor	0.3	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E_{AS}	Single Pulse Avalanche Energy ②⑥	230	mJ
I_{AR}	Avalanche Current ①⑥	16	A
E_{AR}	Repetitive Avalanche Energy ①⑥	4.5	mJ
dv/dt	Peak Diode Recovery dv/dt ③⑥	5.0	V/ns
T_J	Operating Junction and	-55 to + 175	°C
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	—	3.3	°C/W
$R_{\theta JA}$	Junction-to-Ambient	—	—	65	

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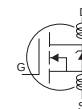
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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	55	—	—	V	V _{GS} = 0V, I _D = 250μA
ΔV _{(BR)DSS} /ΔT _J	Breakdown Voltage Temp. Coefficient	—	0.017	—	V/°C	Reference to 25°C, I _D = 1mA⑥
R _{DS(on)}	Static Drain-to-Source On-Resistance	—	—	0.020	Ω	V _{GS} = 10V, I _D = 19A ④
V _{GS(th)}	Gate Threshold Voltage	2.0	—	4.0	V	V _{DS} = V _{GS} , I _D = 250μA
g _{fs}	Forward Transconductance	16	—	—	S	V _{DS} = 25V, I _D = 28A⑥
I _{DSS}	Drain-to-Source Leakage Current	—	—	25	μA	V _{DS} = 55V, V _{GS} = 0V
		—	—	250	μA	V _{DS} = 44V, V _{GS} = 0V, T _J = 150°C
I _{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	V _{GS} = 20V
	Gate-to-Source Reverse Leakage	—	—	-100	nA	V _{GS} = -20V
Q _g	Total Gate Charge	—	—	61	nC	I _D = 28A
Q _{gs}	Gate-to-Source Charge	—	—	13	nC	V _{DS} = 44V
Q _{gd}	Gate-to-Drain ("Miller") Charge	—	—	24	nC	V _{GS} = 10V, See Fig. 6 and 13 ④⑥
t _{d(on)}	Turn-On Delay Time	—	12	—	ns	V _{DD} = 28V
t _r	Rise Time	—	80	—	ns	I _D = 28A
t _{d(off)}	Turn-Off Delay Time	—	43	—	ns	R _G = 12Ω
t _f	Fall Time	—	52	—	ns	R _D = 0.98Ω, See Fig. 10 ④⑥
L _D	Internal Drain Inductance	—	4.5	—	nH	Between lead, 6mm (0.25in.) from package and center of die contact
L _S	Internal Source Inductance	—	7.5	—	nH	
C _{iss}	Input Capacitance	—	1500	—	pF	V _{GS} = 0V
C _{oss}	Output Capacitance	—	450	—	pF	V _{DS} = 25V
C _{rss}	Reverse Transfer Capacitance	—	160	—	pF	f = 1.0MHz, See Fig. 5⑥
C	Drain to Sink Capacitance	—	12	—	pF	f = 1.0MHz



Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I _S	Continuous Source Current (Body Diode)	—	—	33	A	MOSFET symbol showing the integral reverse p-n junction diode.
I _{SM}	Pulsed Source Current (Body Diode) ①⑥	—	—	180	A	
V _{SD}	Diode Forward Voltage	—	—	1.3	V	T _J = 25°C, I _S = 19A, V _{GS} = 0V ④
t _{rr}	Reverse Recovery Time	—	72	110	ns	T _J = 25°C, I _F = 28A
Q _{rr}	Reverse Recovery Charge	—	210	310	nC	di/dt = 100A/μs ④⑥

Notes:

① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)

③ I_{SD} ≤ 28A, di/dt ≤ 240A/μs, V_{DD} ≤ V_{(BR)DSS}, T_J ≤ 175°C

⑤ t=60s, f=60Hz

② V_{DD} = 25V, starting T_J = 25°C, L = 410μH
R_G = 25Ω, I_{AS} = 28A. (See Figure 12)

④ Pulse width ≤ 300μs; duty cycle ≤ 2%.

⑥ Uses IRFZ46N data and test conditions

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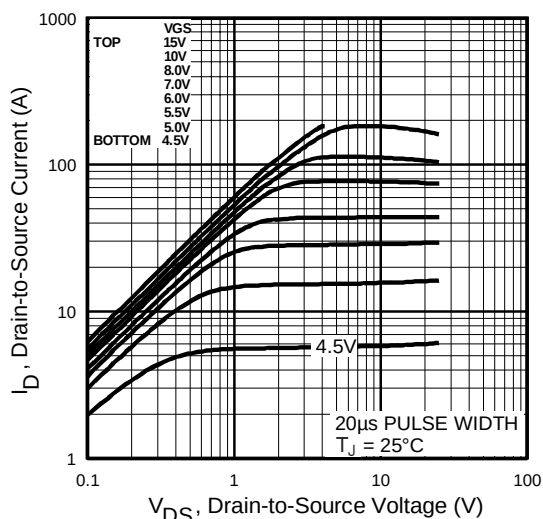


Fig 1. Typical Output Characteristics

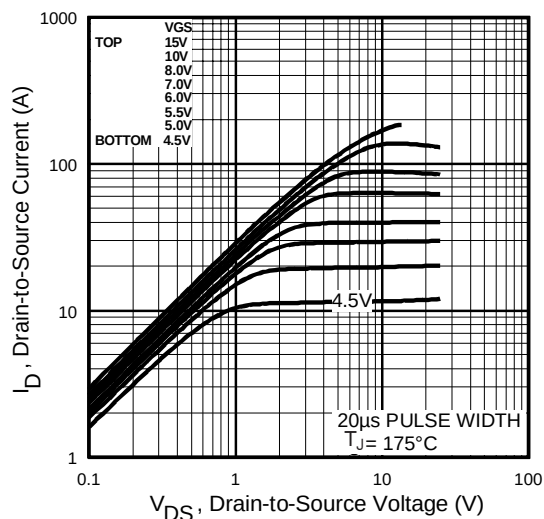


Fig 2. Typical Output Characteristics

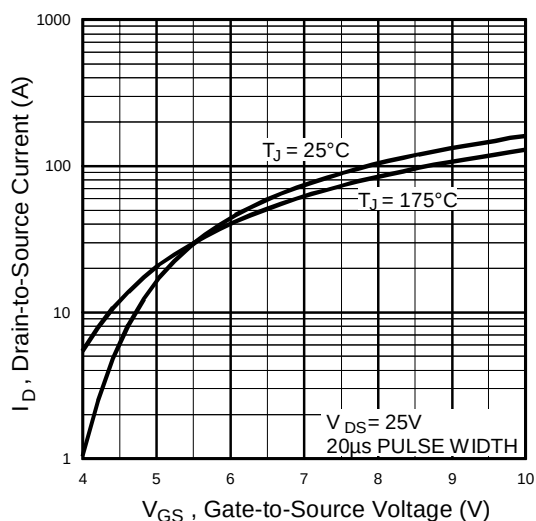


Fig 3. Typical Transfer Characteristics

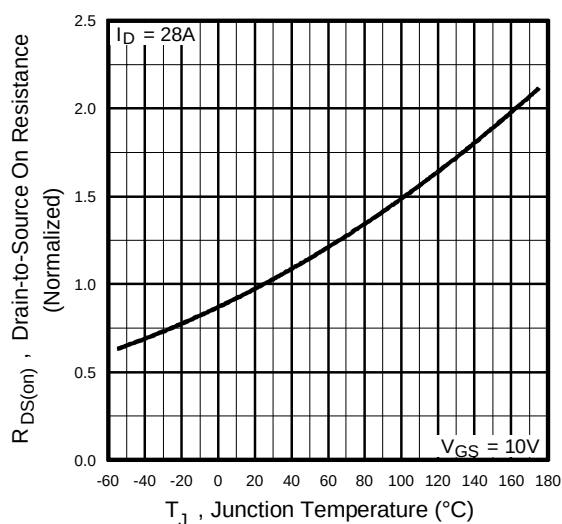


Fig 4. Normalized On-Resistance Vs. Temperature

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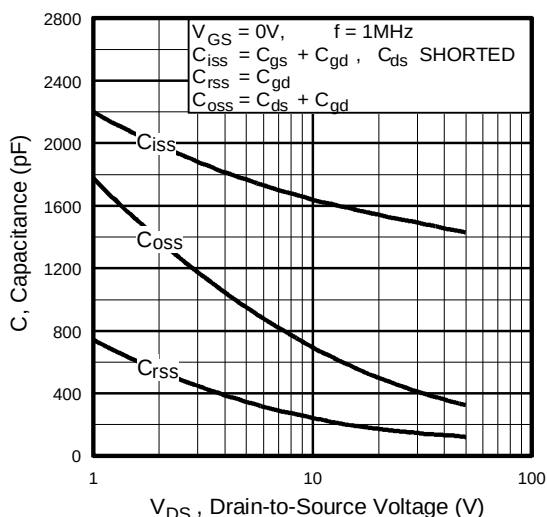


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

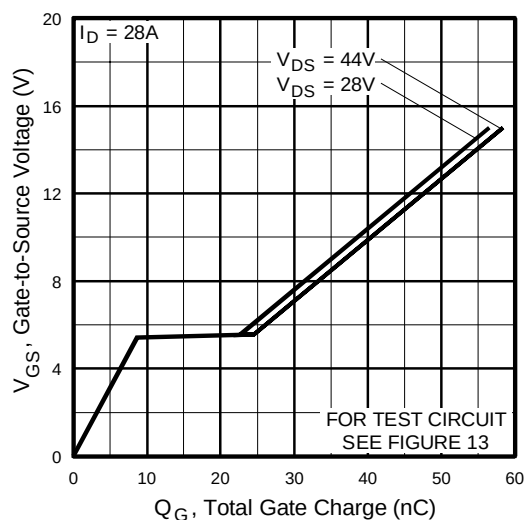


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

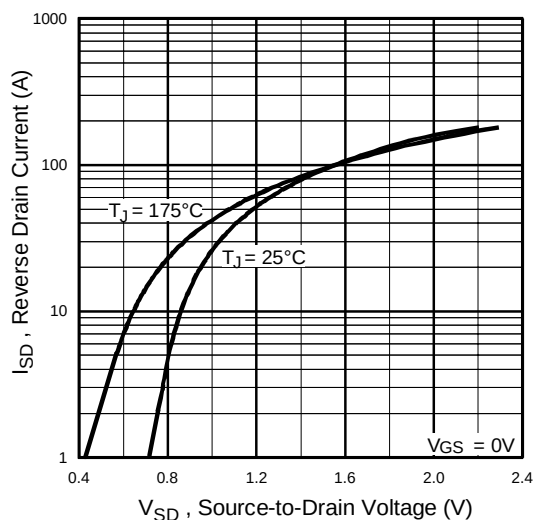


Fig 7. Typical Source-Drain Diode Forward Voltage

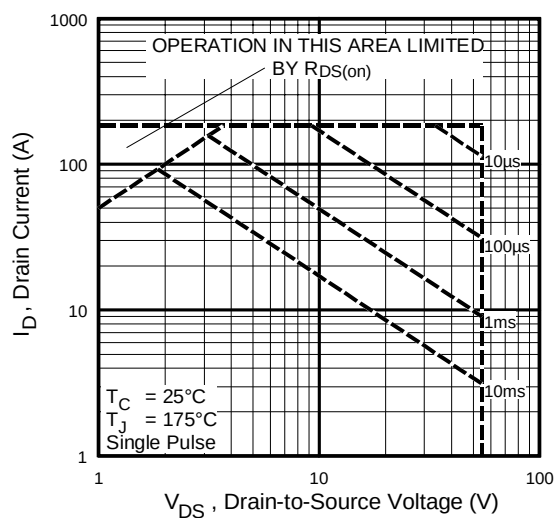


Fig 8. Maximum Safe Operating Area

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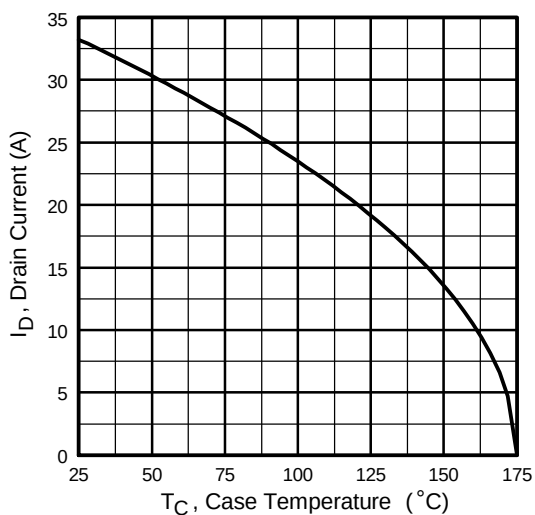


Fig 9. Maximum Drain Current Vs. Case Temperature

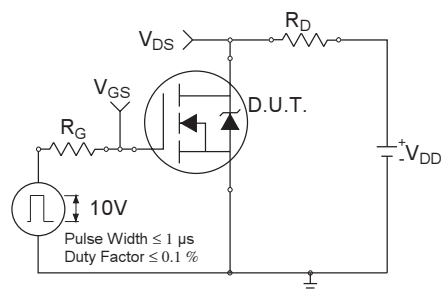


Fig 10a. Switching Time Test Circuit

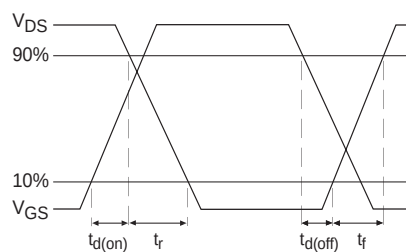


Fig 10b. Switching Time Waveforms

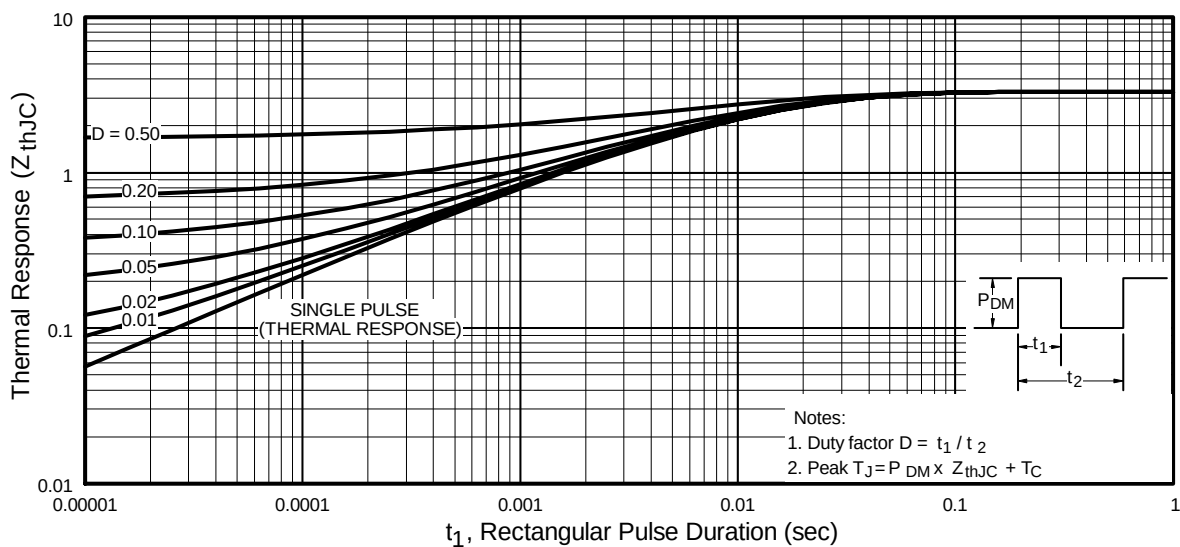


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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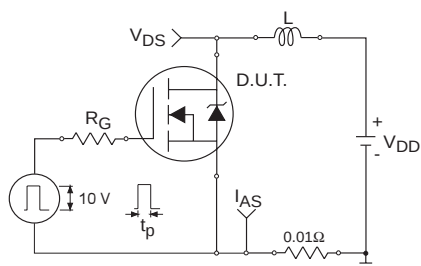


Fig 12a. Unclamped Inductive Test Circuit

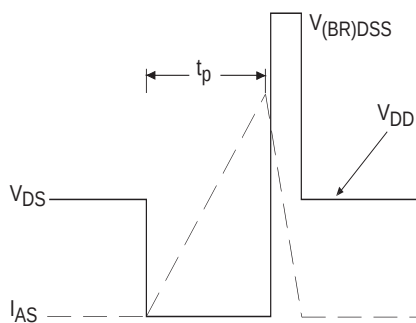


Fig 12b. Unclamped Inductive Waveforms

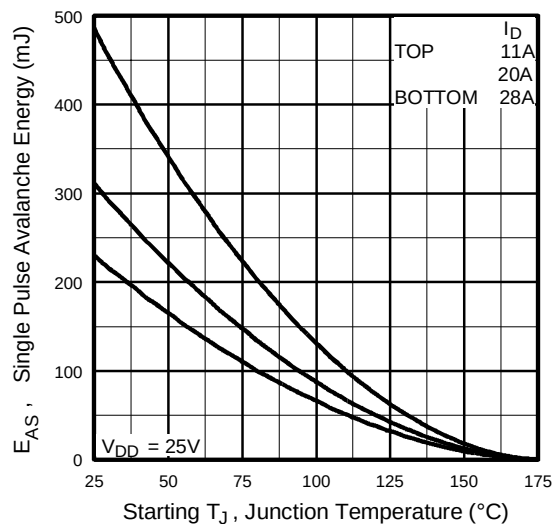


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

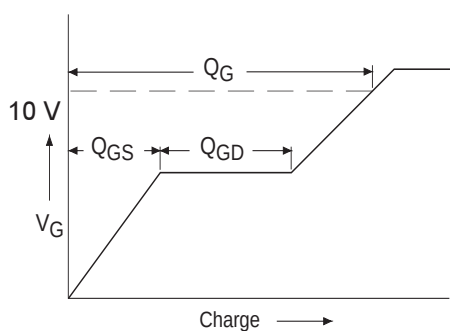


Fig 13a. Basic Gate Charge Waveform

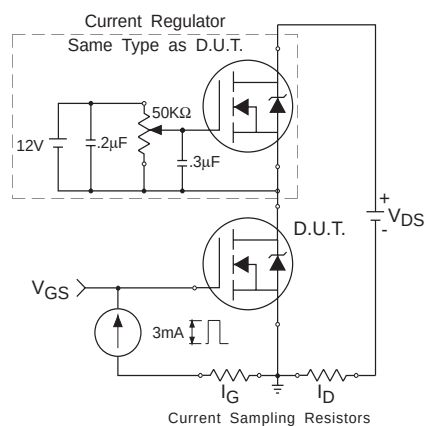


Fig 13b. Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

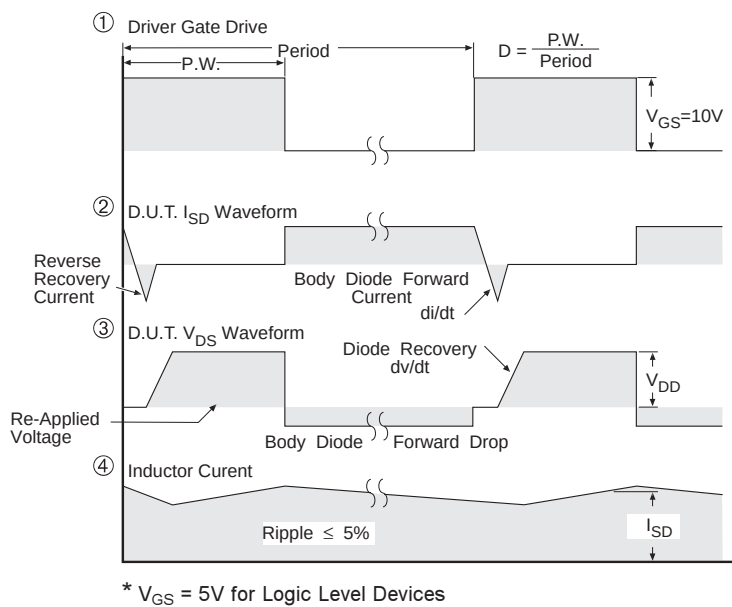
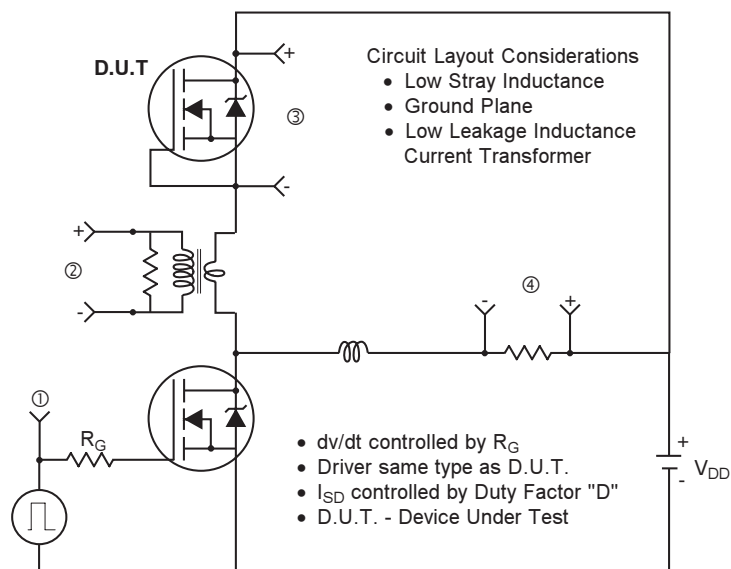


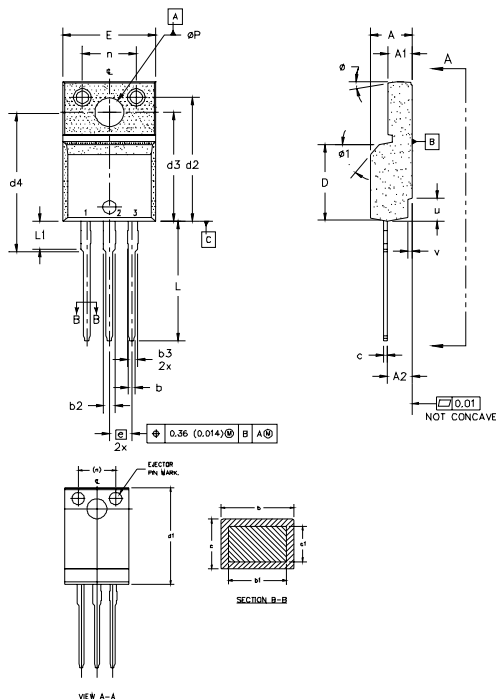
Fig 14. For N-Channel HEXFETS

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TO-220 Full-Pak Package Outline

Dimensions are shown in millimeters (inches)

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NOTES:
1.0 DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994.
2.0 DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
3.0 LEAD DIMENSION AND FINISH UNCONTROLLED IN L1.
4.0 DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
5.0 DIMENSION b1 APPLY TO BASE METAL ONLY.
6.0 STEP OPTIONAL ON PLASTIC BODY DEFINED BY DIMENSIONS u & v.
7.0 CONTROLLING DIMENSION - INCHES.

SYMBOL	DIMENSIONS		DIMENSIONS		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.57	4.83	0.180	0.190	5
A1	2.57	2.83	0.101	0.114	
A2	2.51	2.85	0.099	0.112	
b	0.622	0.89	0.024	0.035	
b1	0.622	0.838	0.024	0.033	
b2	1.229	1.400	0.048	0.055	4
b3	1.229	1.400	0.048	0.055	
c	0.440	0.629	0.017	0.025	
d1	0.440	0.584	0.017	0.023	
d2	8.65	9.80	0.341	0.386	
d3	16.80	16.12	0.622	0.635	4
d4	13.97	14.22	0.550	0.560	
d5	12.30	12.92	0.484	0.509	
d6	8.64	9.91	0.340	0.390	
E	10.36	10.63	0.408	0.419	
e	2.54	BSC	0.100	BSC	3
L	13.20	13.73	0.520	0.541	
L1	3.10	3.50	0.122	0.138	
n	6.05	6.15	0.238	0.242	
øP	3.05	3.45	0.120	0.136	
u	2.40	2.50	0.094	0.098	6
v	0.40	0.50	0.016	0.020	
ø	3"	7"	3"	7"	6
ø1	45°		45°		

LEAD ASSIGNMENTS

HEXFET

1 - GATE
2 - DRAIN
3 - SOURCE

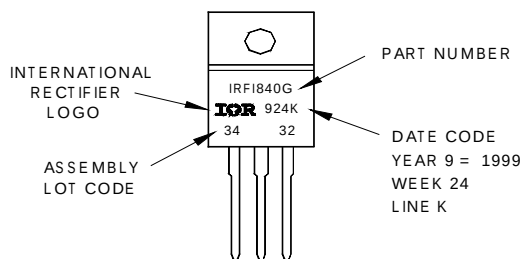
IRFIZ CoPACK

1 - GATE
2 - COLLECTOR
3 - EMITTER

TO-220 Full-Pak Part Marking Information

EXAMPLE: THIS IS AN IRF1840G
WITH ASSEMBLY
LOT CODE 3432
ASSEMBLED ON WW 24 1999
IN THE ASSEMBLY LINE "K"

Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.

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Note: For the most current drawings please refer to the IR website at:

<http://www.irf.com/package/>